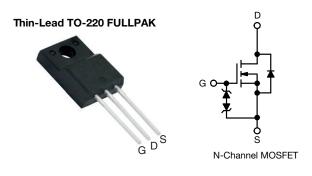
SiHA6N80AE

Vishay Siliconix



E Series Power MOSFET



PRODUCT SUMMARY					
V _{DS} (V) at T _J max.	850				
R _{DS(on)} typ. (Ω) at 25 °C	$V_{GS} = 10 V$	0.826			
Q _g max. (nC)	22.5				
Q _{gs} (nC)	4				
Q _{gd} (nC)	7				
Configuration	Single				

FEATURES

- Low figure-of-merit (FOM) Ron x Qa
- Low effective capacitance (Ciss)
- · Reduced switching and conduction losses
- Ultra low gate charge (Q_q)
- Avalanche energy rated (UIS)
- Integrated Zener diode ESD protection
- · Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

- · Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
 - Battery chargers
 - Renewable energy

ORDERING INFORMATION	
Package	Thin-Lead TO-220 FULLPAK
Lead (Pb)-free and halogen-free	SiHA6N80AE-GE3

ABSOLUTE MAXIMUM RATINGS ($T_C = 25 \text{ °C}$, unless otherwise noted)							
PARAMETER			SYMBOL	LIMIT	UNIT		
Drain-source voltage			V _{DS}	800	V		
Gate-source voltage			V _{GS}	± 30	v		
Continuous drain current (T _J = 150 °C) e	V _{GS} at 10 V	T _C = 25 °C T _C = 100 °C	ID	5			
	VGS at TO V	T _C = 100 °C		3.2	А		
Pulsed drain current ^a			I _{DM}	10			
Linear derating factor				0.24	W/°C		
Single pulse avalanche energy ^b			E _{AS}	20.3	mJ		
Maximum power dissipation			PD	30	W		
Operating junction and storage temperature range		T _J , T _{stg}	-55 to +150	°C			
Drain-source voltage slope		T _J = 125 °C	du (dt	70	1//20		
Reverse diode dv/dt d		dv/dt	0.4	V/ns			
Soldering recommendations (peak temperature	e) ^c	For 10 s		260	°C		
Mounting torque, M3 screw				0.6	Nm		

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature b. V_{DD} = 140 V, starting T_J = 25 °C, L = 28.2 mH, R_g = 25 Ω , I_{AS} = 1.2 A c. 1.6 mm from case

c. 1.6 mm from case d. $I_{SD} \le I_{D}$, di/dt = 100 A/µs, starting T_J = 25 °C e. Limited by maximum junction temperature

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COMPLIANT HALOGEN FREE



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THERMAL RESISTANCE RAT	INGS								
PARAMETER	SYMBOL	TYP.		MAX.		UNIT			
Maximum junction-to-ambient	R _{thJA}	- 65			°044/				
Maximum junction-to-case (drain)	R _{thJC}	- 4.2				- °C/W			
SPECIFICATIONS ($T_J = 25 \ ^{\circ}C$,	unless otherwi	se noted)							
PARAMETER	SYMBOL	TES	T CONDIT	IONS	MIN.	TYP.	MAX.	UNIT	
Static					-				
Drain-source breakdown voltage	V _{DS}	V _{GS} =	= 0 V, I _D = 2	250 µA	800	-	-	V	
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C,	I _D = 1 mA	-	0.8	-	V/°C	
Gate-source threshold voltage (N)	V _{GS(th)}	V _{DS} =	$V_{GS}, I_D = 2$	250 µA	2	-	4	V	
		$V_{GS} = \pm 20 V$			-	-	± 10	•	
Gate-source leakage	I _{GSS}	$V_{GS} = \pm 30 \text{ V}$			-	-	± 50	μA	
Zara gata valtaga drain avreat	I	V _{DS} = 800 V, V _{GS} = 0 V		_S = 0 V	-	-	1		
Zero gate voltage drain current	I _{DSS}	V _{DS} = 640 V, V _{GS} = 0 V, T _J = 125 °C			-	-	10	μA	
Drain-source on-state resistance	R _{DS(on)}	$V_{GS} = 10 V$		_D = 2 A	-	0.826	0.950	Ω	
Forward transconductance ^a	9 _{fs}	V _{DS}	= 30 V, I _D	= 3 A	-	1.9	-	S	
Dynamic	-	•					•	•	
Input capacitance	C _{iss}	$V_{GS} = 0 V,$ $V_{DS} = 100 V,$ f = 1 MHz		-	422	-	pF		
Output capacitance	C _{oss}			-	24	-			
Reverse transfer capacitance	C _{rss}			-	4	-			
Effective output capacitance, energy related ^a	C _{o(er)}	V_{DS} = 0 V to 480 V, V_{GS} = 0 V		-	17	-			
Effective output capacitance, time related ^b	C _{o(tr)}			-	92	-			
Total gate charge	Qg				-	15	22.5		
Gate-source charge	Q _{gs}	V _{GS} = 10 V	$V_{GS} = 10 \text{ V}$ $I_D = 3 \text{ A}, V_{DS} = 640 \text{ V}$		-	4	-	nC	
Gate-drain charge	Q _{gd}				-	7	-	1	
Turn-on delay time	t _{d(on)}				-	12	24		
Rise time	t _r	V _{DD} = 640 V, I _D = 3 A,		-	10	20	1		
Turn-off delay time	t _{d(off)}	V _{GS} =	$V_{GS} = 10 \text{ V}, \text{ R}_{g} = 9.1 \Omega$		-	16	32	ns	
Fall time	t _f			-	20	40	1		
Gate input resistance	R _g	f = 1 MHz, open drain		1	2	4	Ω		
Drain-Source Body Diode Characterist	ics								
Continuous source-drain diode current	١ _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	5	A		
Pulsed diode forward current	I _{SM}			-	-	10			
Diode forward voltage	V _{SD}	T _J = 25 °C, I _S = 3 A, V _{GS} = 0 V		-	-	1.2	V		
Reverse recovery time	t _{rr}	$T_J = 25 \text{ °C}, I_F = I_S = 3 \text{ A},$ di/dt = 100 A/µs, V _R = 25 V		-	285	570	ns		
Reverse recovery charge	Q _{rr}			-	1.7	3.4	μC		
Reverse recovery current	I _{RRM}			-	9.9	-	A		

Notes

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 V to 480 V V_{DSS}

b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 V to 480 V V_{DSS}

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

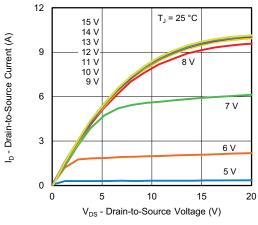


Fig. 1 - Typical Output Characteristics

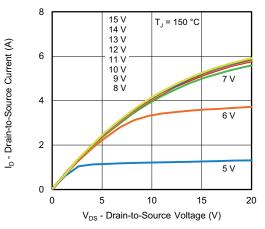


Fig. 2 - Typical Output Characteristics

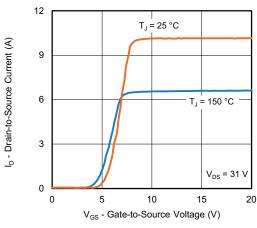


Fig. 3 - Typical Transfer Characteristics

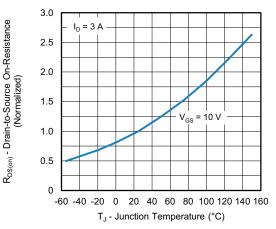


Fig. 4 - Normalized On-Resistance vs. Temperature

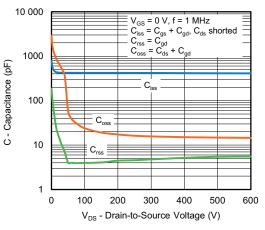


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

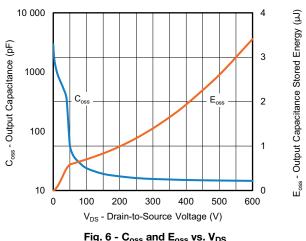


Fig. 6 - Coss and Eoss vs. VDS

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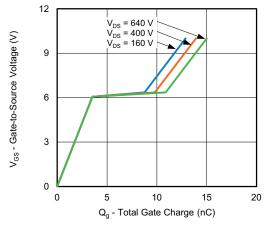


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

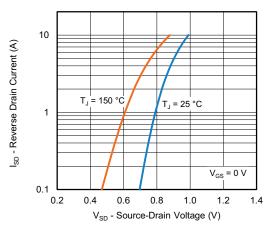


Fig. 8 - Typical Source-Drain Diode Forward Voltage

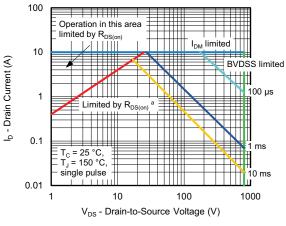
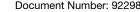


Fig. 9 - Maximum Safe Operating Area

Note

a. V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified

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6 5 l_D - Drain Current (A) 4 3 2 1 0 25 50 75 100 125 150 T_C - Case Temperature (°C)

Fig. 10 - Maximum Drain Current vs. Case Temperature

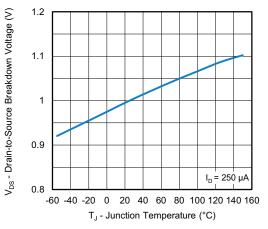
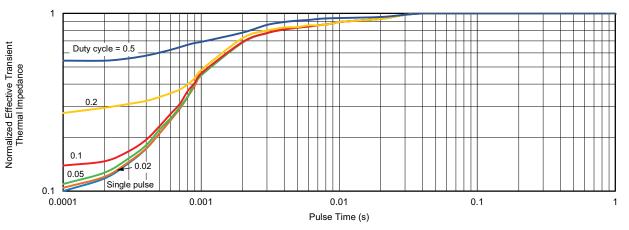


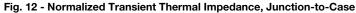
Fig. 11 - Temperature vs. Drain-to-Source Voltage

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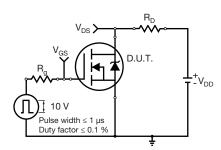


Fig. 13 - Switching Time Test Circuit

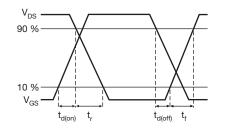


Fig. 14 - Switching Time Waveforms

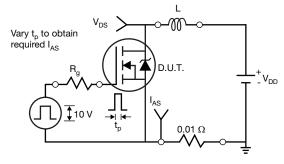


Fig. 15 - Unclamped Inductive Test Circuit

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'n V_{DD} V_{DS} I_{AS}

Fig. 16 - Unclamped Inductive Waveforms

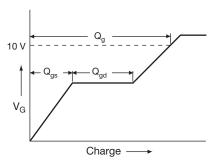
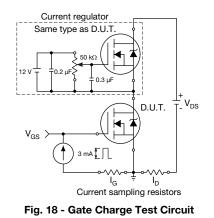


Fig. 17 - Basic Gate Charge Waveform



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Peak Diode Recovery dv/dt Test Circuit

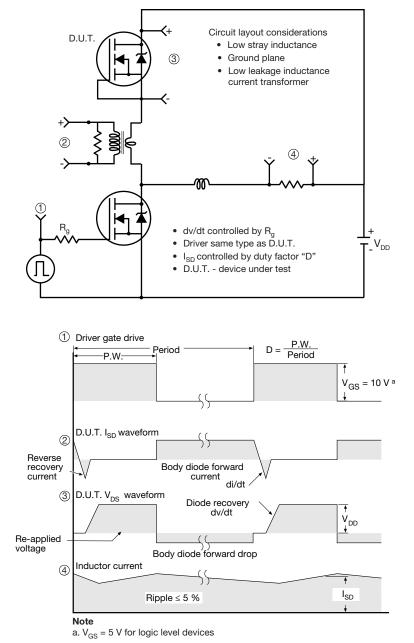


Fig. 19 - For N-Channel

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